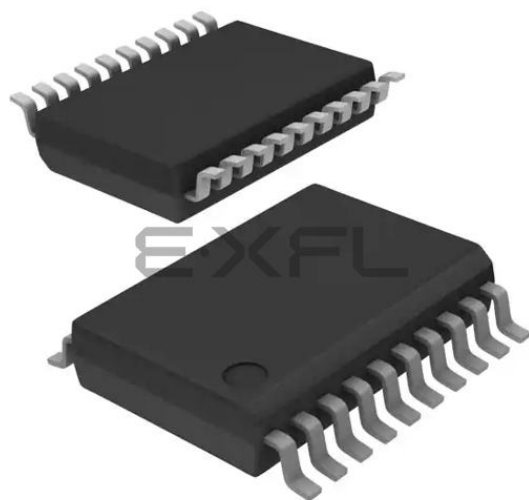




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Details

Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	11
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0421hh020ec00tr

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Block Diagram

Figure 1 displays the block diagram of the architecture of Z8 Encore! XP[®] F0822 Series devices.

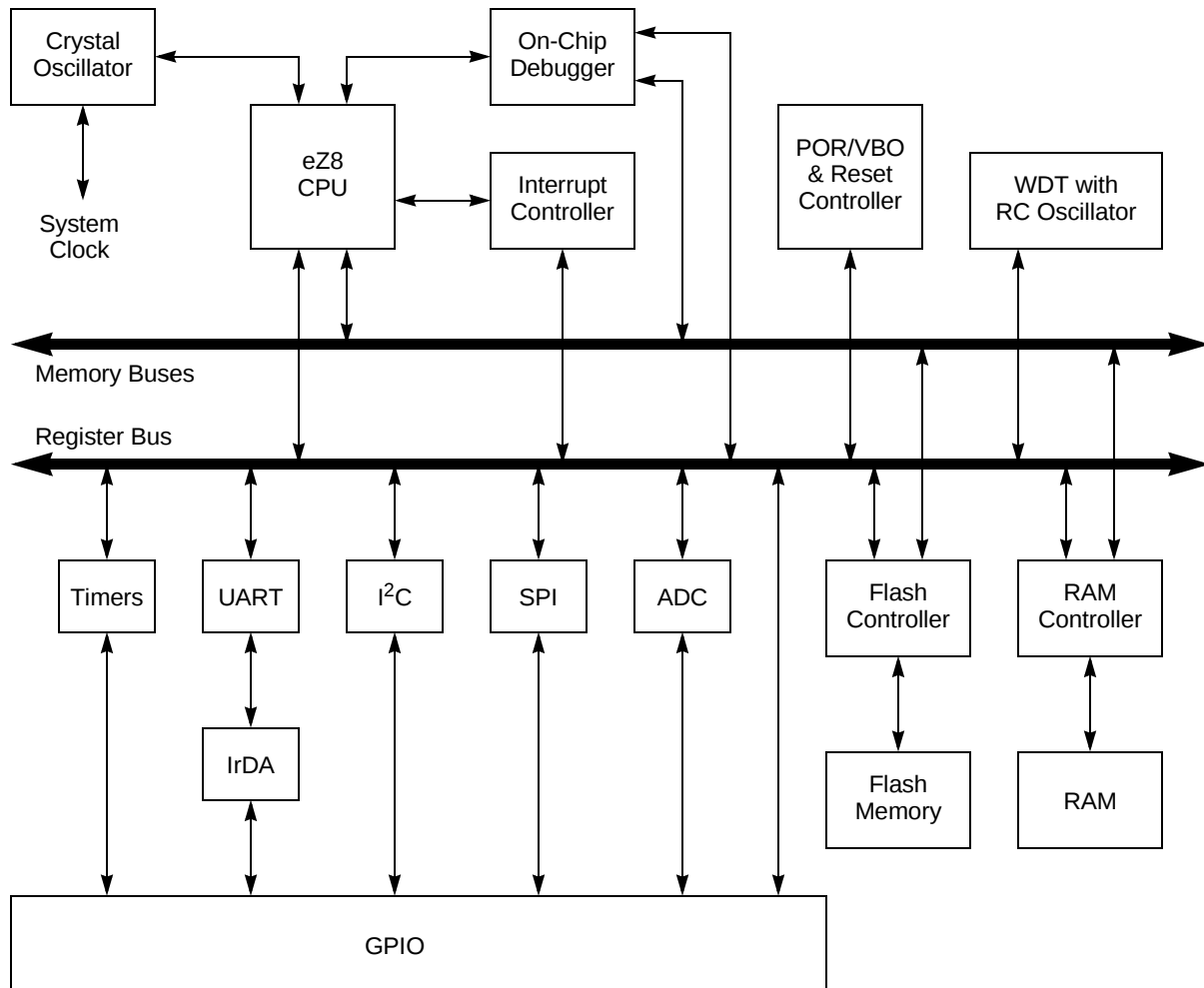


Figure 1. Z8 Encore! XP[®] F0822 Series Block Diagram

CPU and Peripheral Overview

eZ8 CPU Features

Zilog's latest eZ8 8-bit CPU, meets the continuing demand for faster and more code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8[®] instruction set.

Table 3. Signal Descriptions (Continued)

Signal Mnemonic	I/O	Description
Oscillators		
XIN	I	External Crystal Input —This is the input pin to the crystal oscillator. A crystal is connected between the external crystal input and the XOUT pin to form the oscillator. In addition, this pin is used with external RC networks or external clock drivers to provide the system clock to the system.
XOUT	O	External Crystal Output —This pin is the output of the crystal oscillator. A crystal is connected between external crystal output and the XIN pin to form the oscillator. When the system clock is referred in this manual, it refers to the frequency of the signal at this pin. This pin must be left unconnected when not using a crystal.
On-Chip Debugger		
DBG	I/O	Debug —This pin is the control and data input and output to and from the OCD. This pin is open-drain.
! Caution: <i>For operation of the OCD, all power pins (V_{DD} and AV_{DD}) must be supplied with power and all ground pins (V_{SS} and AV_{SS}) must be properly grounded. The DBG pin is open-drain and must have an external pull-up resistor to ensure proper operation.</i>		
Reset		
RESET	I	RESET —Generates a Reset when asserted (driven Low).
Power Supply		
V_{DD}	I	Digital Power Supply.
AV_{DD}	I	Analog Power Supply —Must be powered up and grounded to V_{DD} , even if not using analog features.
V_{SS}	I	Digital Ground.
AV_{SS}	I	Analog Ground —Must be grounded and connected to V_{SS} , even if not using analog features.

Port A–C Output Data Register

The Port A–C Output Data Register (Table 23) controls the output data to the pins.

Table 23. Port A–C Output Data Register (PxOUT)

BITS	7	6	5	4	3	2	1	0
FIELD	POUT7	POUT6	POUT5	POUT4	POUT3	POUT2	POUT1	POUT0
RESET	0							
R/W	R/W							
ADDR	FD3H, FD7H, FDBH							

POUT[7:0]—Port Output Data

These bits contain the data to be driven to the port pins. The values are only driven if the corresponding pin is configured as an output and the pin is not configured for alternate function operation.

0 = Drive a logical 0 (Low).

1 = Drive a logical 1 (High). High value is not driven if the drain has been disabled by setting the corresponding Port Output Control Register bit to 1.

Table 24. Interrupt Vectors in Order of Priority (Continued)

Priority	Program Memory Vector Address	Interrupt Source
	0008H	Reserved
	000AH	Timer 1
	000CH	Timer 0
	000EH	UART 0 receiver
	0010H	UART 0 transmitter
	0012H	I ² C
	0014H	SPI
	0016H	ADC
	0018H	Port A7, rising or falling input edge
	001AH	Port A6, rising or falling input edge
	001CH	Port A5, rising or falling input edge
	001EH	Port A4, rising or falling input edge
	0020H	Port A3, rising or falling input edge
	0022H	Port A2, rising or falling input edge
	0024H	Port A1, rising or falling input edge
	0026H	Port A0, rising or falling input edge
	0028H	Reserved
	002AH	Reserved
	002CH	Reserved
	002EH	Reserved
	0030H	Port C3, both input edges
	0032H	Port C2, both input edges
	0034H	Port C1, both input edges
Lowest	0036H	Port C0, both input edges

Receiving Data Using Interrupt-Driven Method

The UART Receiver interrupt indicates the availability of new data (as well as error conditions). Follow the steps below to configure the UART receiver for interrupt-driven operation:

1. Write to the UART Baud Rate High and Low Byte Registers to set the required baud rate.
2. Enable the UART pin functions by configuring the associated GPIO Port pins for alternate function operation.
3. Execute a `DI` instruction to disable interrupts.
4. Write to the Interrupt Control Registers to enable the UART Receiver interrupt and set the required priority.
5. Clear the UART Receiver interrupt in the applicable Interrupt Request Register.
6. Write to the UART Control 1 Register to enable MULTIPROCESSOR (9-bit) mode functions, if desired.
 - Set the Multiprocessor Mode Select (`MPEN`) to enable MULTIPROCESSOR mode.
 - Set the Multiprocessor Mode Bits, `MPMD [1 : 0]` , to select the required address matching scheme.
 - Configure the UART to interrupt on received data and errors or errors only (interrupt on errors only is unlikely to be useful for Z8 Encore! XP devices without a DMA block)
7. Write the device address to the Address Compare Register (automatic multiprocessor modes only).
8. Write to the UART Control 0 Register to:
 - Set the receive enable bit (`REN`) to enable the UART for data reception
 - Enable parity, if required, and if MULTIPROCESSOR mode is not enabled, and select either even or odd parity.
9. Execute an `EI` instruction to enable interrupts.

The UART is now configured for interrupt-driven data reception. When the UART Receiver Interrupt is detected, the associated ISR performs the following:

1. Check the UART Status 0 Register to determine the source of the interrupt-error, break, or received data.
2. If the interrupt was due to data available, read the data from the UART Receive Data Register. If operating in MULTIPROCESSOR (9-bit) mode, further actions may be required depending on the Multiprocessor Mode bits `MPMD[1:0]`.
3. Clear the UART Receiver Interrupt in the applicable Interrupt Request Register.
4. Execute the `IRET` instruction to return from the ISR and await more data.

UART Receive Data Register

Data bytes received through the RXD_x pin are stored in the UART Receive Data Register (Table 53). The Read-only UART Receive Data Register shares a Register File address with the Write-only UART Transmit Data Register.

Table 53. UART Receive Data Register (U0RXD)

BITS	7	6	5	4	3	2	1	0
FIELD	RXD							
RESET	X							
R/W	R							
ADDR	F40H							

RXD—Receive Data

UART receiver data byte from the RXD_x pin

UART Status 0 Register

The UART Status 0 and Status 1 registers (Table 54 and Table 55 on page 102) identify the current UART operating configuration and status.

Table 54. UART Status 0 Register (U0STAT0)

BITS	7	6	5	4	3	2	1	0
FIELD	RDA	PE	OE	FE	BRKD	TDRE	TXE	CTS
RESET	0					1		X
R/W	R							
ADDR	F41H							

RDA—Receive Data Available

This bit indicates that the UART Receive Data Register has received data. Reading the UART Receive Data Register clears this bit.

0 = The UART Receive Data Register is empty.

1 = There is a byte in the UART Receive Data Register.

PE—Parity Error

This bit indicates that a parity error has occurred. Reading the UART Receive Data Register clears this bit.

0 = No parity error has occurred.

1 = A parity error has occurred.

OE—Overrun Error

This bit indicates that an overrun error has occurred. An overrun occurs when new data is received and the UART Receive Data Register has not been read. If the RDA bit is reset to

For a given UART data rate, the integer baud rate divisor value is calculated using the following equation:

$$\text{UART Baud Rate Divisor Value (BRG)} = \text{Round}\left(\frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Data Rate (bits/s)}}\right)$$

The baud rate error relative to the desired baud rate is calculated using the following equation:

$$\text{UART Baud Rate Error (\%)} = 100 \times \left(\frac{\text{Actual Data Rate} - \text{Desired Data Rate}}{\text{Desired Data Rate}} \right)$$

For reliable communication, the UART baud rate error must never exceed 5 percent. Table 61 provides information on data rate errors for popular baud rates and commonly used crystal oscillator frequencies.

Table 61. UART Baud Rates

10.0 MHz System Clock				5.5296 MHz System Clock			
Desired Rate	BRG Divisor	Actual Rate	Error	Desired Rate	BRG Divisor	Actual Rate	Error
(kHz)	(Decimal)	(kHz)	(%)	(kHz)	(Decimal)	(kHz)	(%)
1250.0	N/A	N/A	N/A	1250.0	N/A	N/A	N/A
625.0	1	625.0	0.00	625.0	N/A	N/A	N/A
250.0	3	208.33	-16.67	250.0	1	345.6	38.24
115.2	5	125.0	8.51	115.2	3	115.2	0.00
57.6	11	56.8	-1.36	57.6	6	57.6	0.00
38.4	16	39.1	1.73	38.4	9	38.4	0.00
19.2	33	18.9	0.16	19.2	18	19.2	0.00
9.60	65	9.62	0.16	9.60	36	9.60	0.00
4.80	130	4.81	0.16	4.80	72	4.80	0.00
2.40	260	2.40	-0.03	2.40	144	2.40	0.00
1.20	521	1.20	-0.03	1.20	288	1.20	0.00
0.60	1042	0.60	-0.03	0.60	576	0.60	0.00
0.30	2083	0.30	0.2	0.30	1152	0.30	0.00

Table 61. UART Baud Rates (Continued)

3.579545 MHz System Clock				1.8432 MHz System Clock			
Desired Rate	BRG Divisor	Actual Rate	Error	Desired Rate	BRG Divisor	Actual Rate	Error
(kHz)	(Decimal)	(kHz)	(%)	(kHz)	(Decimal)	(kHz)	(%)
1250.0	N/A	N/A	N/A	1250.0	N/A	N/A	N/A
625.0	N/A	N/A	N/A	625.0	N/A	N/A	N/A
250.0	1	223.72	-10.51	250.0	N/A	N/A	N/A
115.2	2	111.9	-2.90	115.2	1	115.2	0.00
57.6	4	55.9	-2.90	57.6	2	57.6	0.00
38.4	6	37.3	-2.90	38.4	3	38.4	0.00
19.2	12	18.6	-2.90	19.2	6	19.2	0.00
9.60	23	9.73	1.32	9.60	12	9.60	0.00
4.80	47	4.76	-0.83	4.80	24	4.80	0.00
2.40	93	2.41	0.23	2.40	48	2.40	0.00
1.20	186	1.20	0.23	1.20	96	1.20	0.00
0.60	373	0.60	-0.04	0.60	192	0.60	0.00
0.30	746	0.30	-0.04	0.30	384	0.30	0.00

of minus four baud rate clocks to plus eight baud rate clocks around the expected time of an incoming pulse. If an incoming pulse is detected inside this window this process is repeated. If the incoming data is a logical 1 (no pulse), the Endec returns to the initial state and waits for the next falling edge. As each falling edge is detected, the Endec clock counter is reset, resynchronizing the Endec to the incoming signal. This procedure allows the Endec to tolerate jitter and baud rate errors in the incoming data stream. Resynchronizing the Endec does not alter the operation of the UART, which ultimately receives the data. The UART is only synchronized to the incoming data stream when a Start bit is received.

Infrared Endec Control Register Definitions

All Infrared Endec configuration and status information is set by the UART control registers as defined in UART Control Register Definitions on page 100.

! **Caution:** *To prevent spurious signals during IrDA data transmission, set the `IREN` bit in the UART Control 1 register to 1 to enable the Infrared Endec before enabling the GPIO Port alternate function for the corresponding pin.*

! Caution: *In CONTINUOUS mode, ensure that ADC updates are limited by the input signal bandwidth of the ADC and the latency of the ADC and its digital filter. Step changes at the input are not seen at the next output from the ADC. The response of the ADC (in all modes) is limited by the input signal bandwidth and the latency.*

Follow the steps below for setting up the ADC and initiating continuous conversion:

1. Enable the desired analog input by configuring the GPIO pins for alternate function. This disables the digital input and output driver.
2. Write to the ADC Control Register to configure the ADC for continuous conversion. The bit fields in the ADC Control Register can be written simultaneously:
 - Write to the ANA_{IN}[3 : 0] field to select one of the 5 analog input sources.
 - Set CONT to 1 to select continuous conversion.
 - Write to the $\overline{\text{VREF}}$ bit to enable or disable the internal voltage reference generator.
 - Set CEN to 1 to start the conversions.
3. When the first conversion in continuous operation is complete (after 5129 system clock cycles, plus the 40 cycles for power-up, if necessary), the ADC control logic performs the following operations:
 - CEN resets to 0 to indicate the first conversion is complete. CEN remains 0 for all subsequent conversions in continuous operation.
 - An interrupt request is sent to the Interrupt Controller to indicate the conversion is complete.
4. Thereafter, the ADC writes a new 10-bit data result to {ADCD_H[7:0], ADCD_L[7:6]} every 256 system clock cycles. An interrupt request is sent to the Interrupt Controller when each conversion is complete.
5. To disable continuous conversion, clear the CONT bit in the ADC Control Register to 0.

Flash Memory

The products in Z8 Encore! XP[®] F0822 Series feature either 8 KB (8192) or 4 KB (4096) bytes of Flash memory with Read/Write/Erase capability. The Flash memory is programmed and erased in-circuit by either user code or through the OCD.

The Flash memory array is arranged in 512-byte per page. The 512-byte page is the minimum Flash block size that can be erased. The Flash memory is divided into eight sectors which is protected from programming and erase operations on a per sector basis.

Table 80 describes the Flash memory configuration for each device in the Z8F082x family. Table 81 lists the sector address ranges. Figure 33 on page 154 displays the Flash memory arrangement.

Table 80. Flash Memory Configurations

Part Number	Flash Size	Number of Pages	Flash Memory Addresses	Sector Size	Number of Sectors	Pages per Sector
Z8F08xx	8 KB (8192)	16	0000H - 1FFFFH	1 KB (1024)	8	2
Z8F04xx	4 KB (4096)	8	0000H - 0FFFFH	0.5 KB (512)	8	1

Table 81. Flash Memory Sector Addresses

Sector Number	Flash Sector Address Ranges	
	Z8F04xx	Z8F08xx
0	0000H-01FFFH	0000H-03FFFH
1	0200H-03FFFH	0400H-07FFFH
2	0400H-05FFFH	0800H-0BFFFH
3	0600H-07FFFH	0C00H-0FFFFH
4	0800H-09FFFH	1000H-13FFFH
5	0A00H-0BFFFH	1400H-17FFFH
6	0C00H-0DFFFH	1800H-1BFFFH
7	0E00H-0FFFFH	1C00H-1FFFFH

Flash Status Register

The Flash Status Register (Table 84) indicates the current state of the Flash Controller. This register can be read at any time. The Read-only Flash Status Register shares its Register File address with the Write-only Flash Control Register.

Table 84. Flash Status Register (FSTAT)

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved		FSTAT					
RESET	0							
R/W	R							
ADDR	FF8H							

Reserved

These bits are reserved and must be 0.

FSTAT—Flash Controller Status

00_0000 = Flash Controller locked.

00_0001 = First unlock command received.

00_0010 = Second unlock command received.

00_0011 = Flash Controller unlocked.

00_0100 = Flash Sector Protect Register selected.

00_1xxx = Program operation in progress.

01_0xxx = Page erase operation in progress.

10_0xxx = Mass erase operation in progress.

Page Select Register

The Page Select (FPS) Register (Table 85) selects the Flash memory page to be erased or programmed. Each Flash Page contains 512 bytes of Flash memory. During a Page Erase operation, all Flash memory locations with the 7 most significant bits of the address given by the PAGE field are erased to FFH.

The Page Select Register shares its Register File address with the Flash Sector Protect Register. The Page Select Register cannot be accessed when the Flash Sector Protect Register is enabled.

Table 85. Page Select Register (FPS)

BITS	7	6	5	4	3	2	1	0
FIELD	INFO_EN	PAGE						
RESET	0							
R/W	R/W							
ADDR	FF9H							

Figure 43 displays the typical current consumption in HALT mode while operating at 25 °C versus the system clock frequency. All GPIO pins are configured as outputs and driven High.

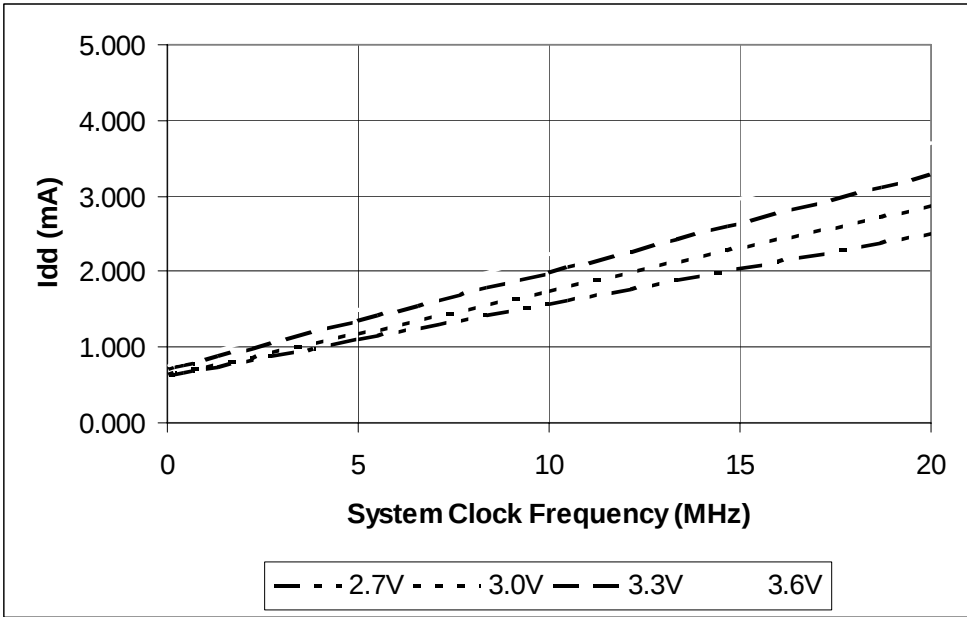


Figure 43. Typical HALT Mode I_{DD} Versus System Clock Frequency

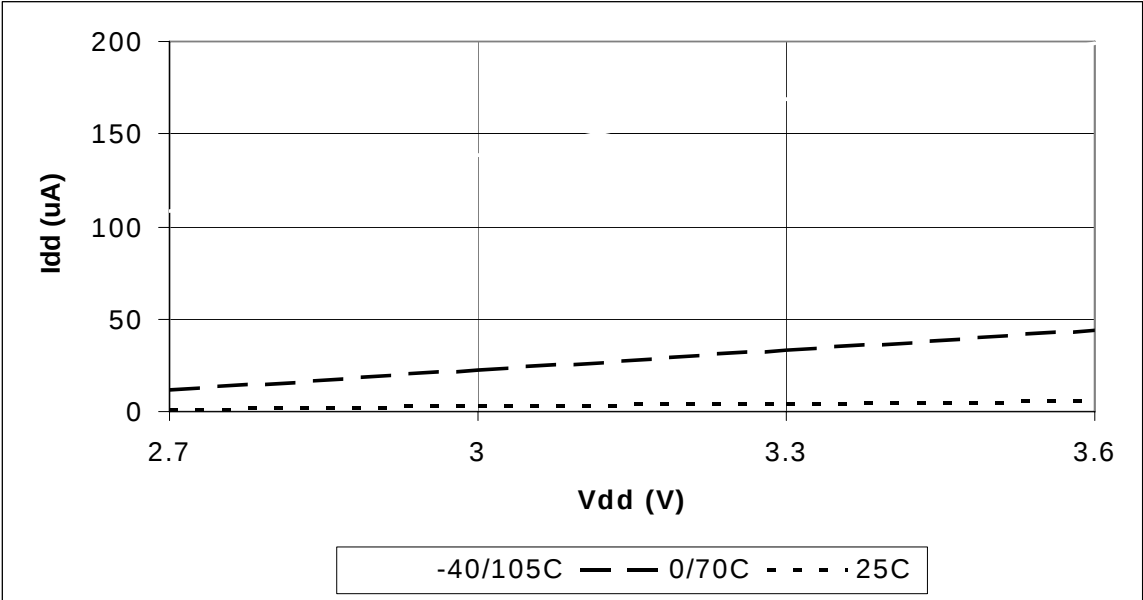


Figure 46. Maximum STOP Mode I_{DD} with VBO Disabled versus Power Supply Voltage

Table 118. Arithmetic Instructions (Continued)

Mnemonic	Operands	Instruction
SBC	dst, src	Subtract with Carry
SBCX	dst, src	Subtract with Carry using Extended Addressing
SUB	dst, src	Subtract
SUBX	dst, src	Subtract using Extended Addressing

Table 119. Bit Manipulation Instructions

Mnemonic	Operands	Instruction
BCLR	bit, dst	Bit Clear
BIT	p, bit, dst	Bit Set or Clear
BSET	bit, dst	Bit Set
BSWAP	dst	Bit Swap
CCF	—	Complement Carry Flag
RCF	—	Reset Carry Flag
SCF	—	Set Carry Flag
TCM	dst, src	Test Complement Under Mask
TCMX	dst, src	Test Complement Under Mask using Extended Addressing
TM	dst, src	Test Under Mask
TMX	dst, src	Test Under Mask using Extended Addressing

Table 120. Block Transfer Instructions

Mnemonic	Operands	Instruction
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses

		Lower Nibble (Hex)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Upper Nibble (Hex)	0	1.2 BRK	2.2 SRP IM	2.3 ADD r1,r2	2.4 ADD r1,lr2	3.3 ADD R2,R1	3.4 ADD IR2,R1	3.3 ADD R1,IM	3.4 ADD IR1,IM	4.3 ADDX ER2,ER1	4.3 ADDX IM,ER1	2.3 DJNZ r1,X	2.2 JR cc,X	2.2 LD r1,IM	3.2 JP cc,DA	1.2 INC r1	1.2 NOP
	1	2.2 RLC R1	2.3 RLC IR1	2.3 ADC r1,r2	2.4 ADC r1,lr2	3.3 ADC R2,R1	3.4 ADC IR2,R1	3.3 ADC R1,IM	3.4 ADC IR1,IM	4.3 ADCX ER2,ER1	4.3 ADCX IM,ER1	See 2nd Opcode Map					
	2	2.2 INC R1	2.3 INC IR1	2.3 SUB r1,r2	2.4 SUB r1,lr2	3.3 SUB R2,R1	3.4 SUB IR2,R1	3.3 SUB R1,IM	3.4 SUB IR1,IM	4.3 SUBX ER2,ER1	4.3 SUBX IM,ER1						
	3	2.2 DEC R1	2.3 DEC IR1	2.3 SBC r1,r2	2.4 SBC r1,lr2	3.3 SBC R2,R1	3.4 SBC IR2,R1	3.3 SBC R1,IM	3.4 SBC IR1,IM	4.3 SBCX ER2,ER1	4.3 SBCX IM,ER1						
	4	2.2 DA R1	2.3 DA IR1	2.3 OR r1,r2	2.4 OR r1,lr2	3.3 OR R2,R1	3.4 OR IR2,R1	3.3 OR R1,IM	3.4 OR IR1,IM	4.3 ORX ER2,ER1	4.3 ORX IM,ER1						
	5	2.2 POP R1	2.3 POP IR1	2.3 AND r1,r2	2.4 AND r1,lr2	3.3 AND R2,R1	3.4 AND IR2,R1	3.3 AND R1,IM	3.4 AND IR1,IM	4.3 ANDX ER2,ER1	4.3 ANDX IM,ER1	1.2 WDT					
	6	2.2 COM R1	2.3 COM IR1	2.3 TCM r1,r2	2.4 TCM r1,lr2	3.3 TCM R2,R1	3.4 TCM IR2,R1	3.3 TCM R1,IM	3.4 TCM IR1,IM	4.3 TCMX ER2,ER1	4.3 TCMX IM,ER1						
	7	2.2 PUSH R2	2.3 PUSH IR2	2.3 TM r1,r2	2.4 TM r1,lr2	3.3 TM R2,R1	3.4 TM IR2,R1	3.3 TM R1,IM	3.4 TM IR1,IM	4.3 TMX ER2,ER1	4.3 TMX IM,ER1						
	8	2.5 DECW RR1	2.6 DECW IRR1	2.5 LDE r1,lr2	2.9 LDEI lr1,lr2	3.2 LDX r1,ER2	3.3 LDX lr1,ER2	3.4 LDX IRR2,R1	3.5 LDX IRR2,IR1	3.4 LDX r1,rr2,X	3.4 LDX rr1,r2,X	1.2 DI					
	9	2.2 RL R1	2.3 RL IR1	2.5 LDE r2,lr1	2.9 LDEI lr2,lr1	3.2 LDX r2,ER1	3.3 LDX lr2,ER1	3.4 LDX R2,IRR1	3.5 LDX IR2,IRR1	3.3 LEA r1,r2,X	3.5 LEA rr1,r2,X						
	A	2.5 INCW RR1	2.6 INCW IRR1	2.3 CP r1,r2	2.4 CP r1,lr2	3.3 CP R2,R1	3.4 CP IR2,R1	3.3 CP R1,IM	3.4 CP IR1,IM	4.3 CPX ER2,ER1	4.3 CPX IM,ER1	1.2 EI					
	B	2.2 CLR R1	2.3 CLR IR1	2.3 XOR r1,r2	2.4 XOR r1,lr2	3.3 XOR R2,R1	3.4 XOR IR2,R1	3.3 XOR R1,IM	3.4 XOR IR1,IM	4.3 XORX ER2,ER1	4.3 XORX IM,ER1						
	C	2.2 RRC R1	2.3 RRC IR1	2.5 LDC r1,lr2	2.9 LDCI lr1,lr2	2.3 JP IRR1	2.9 LDC lr1,lr2		3.4 LD r1,r2,X	3.2 PUSHX ER2							
	D	2.2 SRA R1	2.3 SRA IR1	2.5 LDC r2,lr1	2.9 LDCI lr2,lr1	2.6 CALL IRR1	2.2 BSWAP R1	3.3 CALL DA	3.4 LD r2,r1,X	3.2 POPX ER1							
	E	2.2 RR R1	2.3 RR IR1	2.2 BIT p,b,r1	2.3 LD r1,lr2	3.2 LD R2,R1	3.3 LD IR2,R1	3.2 LD R1,IM	3.3 LD IR1,IM	4.2 LDX ER2,ER1	4.2 LDX IM,ER1	1.2 CCF					
	F	2.2 SWAP R1	2.3 SWAP IR1	2.6 TRAP Vector	2.3 LD lr1,r2	2.8 MULT RR1	3.3 LD R2,IR1	3.3 BTJ p,b,r1,X	3.4 BTJ p,b,lr1,X								

Figure 58. First Opcode Map

		Lower Nibble (Hex)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Upper Nibble (Hex)	0																
	1																
	2																
	3																
	4																
	5																
	6																
	7																
	8																
	9																
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